



**THE DATASHEET OF  
SE15FG-M3/I**



## Surface-Mount Standard Rectifiers

### eSMP® Series



Top view

Bottom view

#### SMF (DO-219AB)

Cathode Anode

### LINKS TO ADDITIONAL RESOURCES


[3D Models](#)

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.5 A
$V_{RRM}$	200 V, 400 V, 600 V
$I_{FSM}$	30 A
$V_F$ at $I_F = 1.5$ A ( $T_A = 125$ °C)	0.86 V
$I_R$	5 $\mu$ A
$T_J$ max.	175 °C
Package	SMF (DO-219AB)
Circuit configuration	Single

### FEATURES

- Low profile package
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available  
- Automotive ordering code: base P/NHM3
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### TYPICAL APPLICATIONS

General purpose, power line polarity protection, in commercial, industrial, and automotive applications.

### MECHANICAL DATA

**Case:** SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - for halogen-free, and RoHS-compliant

Base P/NHM3 - for halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes the cathode end

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)					
PARAMETER	SYMBOL	SE15FD	SE15FG	SE15FJ	UNIT
Device marking code		BD	BG	BJ	
Maximum repetitive peak reverse voltage	$V_{RRM}$	200	400	600	V
Maximum DC forward current	$I_{F(AV)}$ <sup>(1)</sup>	1.5			A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	30			A
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +175			°C

#### Note

<sup>(1)</sup> Free air, mounted on recommended PCB, 2 oz. pad area



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 1.5\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.96	1.05	V
		$T_A = 125\text{ }^\circ\text{C}$		0.86	0.95	
Reverse current	Rated $V_R$	$T_A = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	-	5	$\mu\text{A}$
		$T_A = 125\text{ }^\circ\text{C}$		19	50	
Typical reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$		$t_{rr}$	900	-	ns
Typical junction capacitance	4.0 V, 1 MHz		$C_J$	10.5	-	pF

**Notes**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle(2) Pulse test: Pulse width  $\leq 40\text{ ms}$ 

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
PARAMETER	SYMBOL	SE15FD	SE15FG	SE15FJ	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	130			$^\circ\text{C/W}$
	$R_{\theta JM}^{(1)}$	20			

**Note**(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient;  $R_{\theta JM}$  - junction to mount

<b>IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100\text{ pF}, R = 1.5\text{ k}\Omega$	$V_C$	H3B	$> 8\text{ kV}$

<b>ORDERING INFORMATION</b> (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE15FJ-M3/H	0.015	H	3000	7" diameter plastic tape and reel
SE15FJ-M3/I	0.015	I	10 000	13" diameter plastic tape and reel
SE15FJHM3/H <sup>(1)</sup>	0.015	H	3000	7" diameter plastic tape and reel
SE15FJHM3/I <sup>(1)</sup>	0.015	I	10 000	13" diameter plastic tape and reel

**Note**

(1) AEC-Q101 qualified



## RATINGS AND CHARACTERISTICS CURVES ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

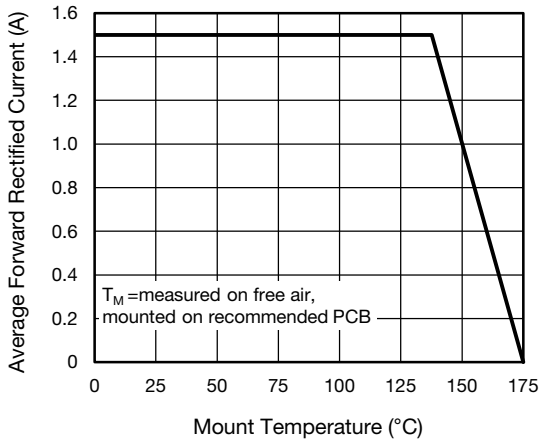


Fig. 1 - Maximum Forward Current Derating Curve

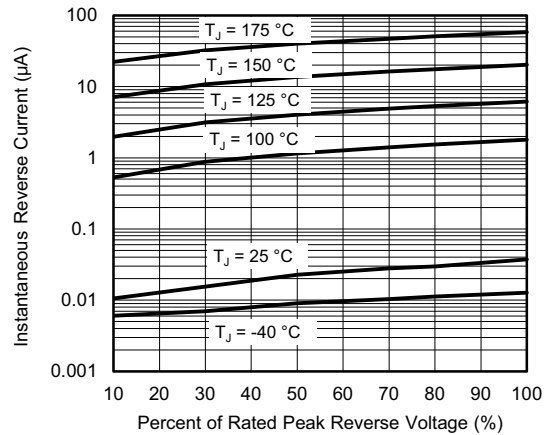


Fig. 4 - Typical Reverse Leakage Characteristics

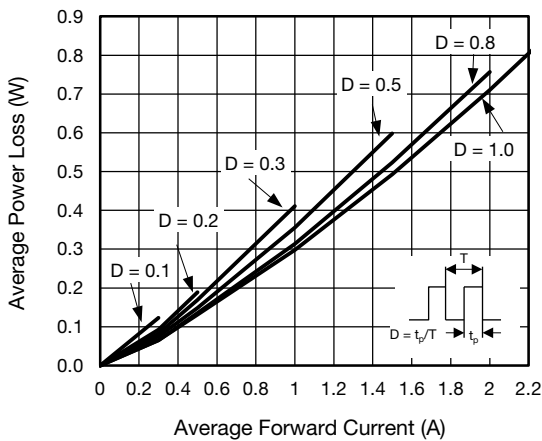


Fig. 2 - Average Power Loss Characteristics

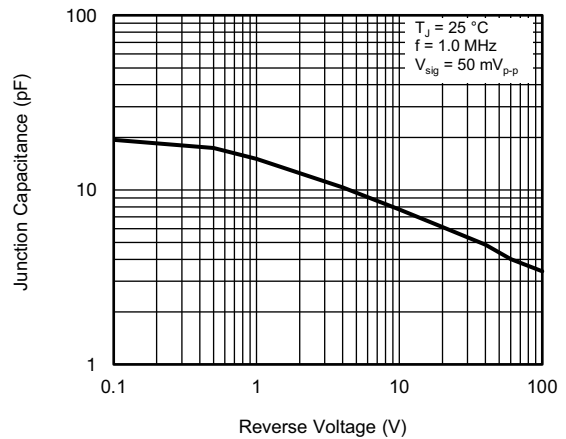


Fig. 5 - Typical Junction Capacitance

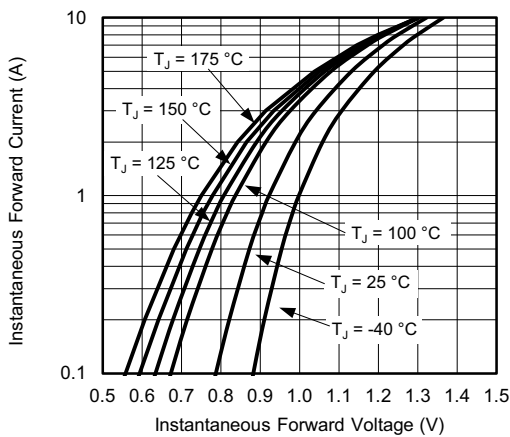


Fig. 3 - Typical Instantaneous Forward Characteristics

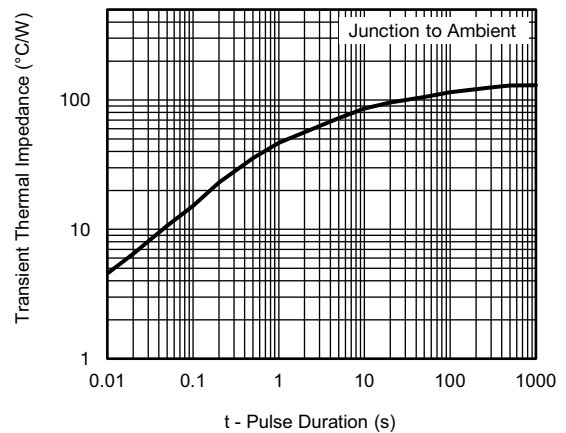
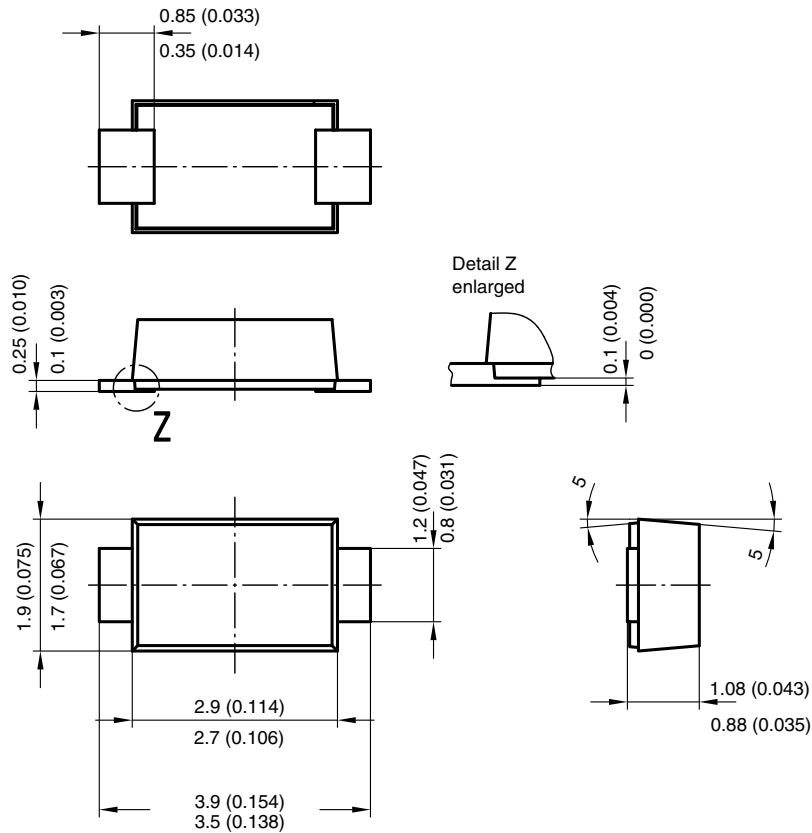


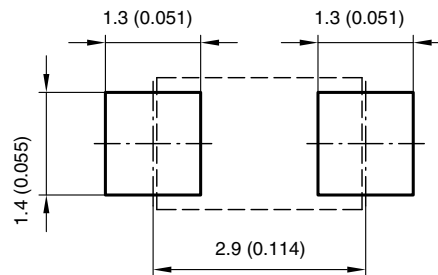
Fig. 6 - Typical Transient Thermal Impedance



### PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



Created - Date: 15. February 2005  
 Rev. 3 - Date: 13. March 2007  
 Document no.:S8-V-3915.01-001 (4)  
 17247



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